## Bean Revision E

P/N: PTD1013012E info@punchthrough.com

Rev E

Top Silk: tPlace tArt

Bottom Silk: bArt

Layers: 2

Rectangular Dimensions: 1.775" x 0.8" (45.09mm x 20.32mm)

Finished Thickness: 0.062"

Finish: ENIG Material: FR4

Copper Weight: 1oz

Soldermask: Top and bottom Silkscreen: Top and Bottom Silkscreen Color: Black

Soldermask Color: 85% white 10% green 5% blue

Min Drill: 0.008"

Min Annular Ring: 0.006" Min Trace: 0.007"

Min Spacing: 0.005"

Corner mill radius: 0.32"

Avoid placing copper in antenna keepout



